

App. No. 10/607,613
Amend. Dated 10/4/04
Response To Action dated 8/3/04

O I P E
OCT 07 2004
PATENT & TRADEMARK
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
In re the application of
Kiermasz et al.
Application No: 10/607,613
Filed: June 27, 2003
For: PLATEN WITH DIAPHRAGM AND
METHOD FOR OPTIMIZING WAFER
POLISHING

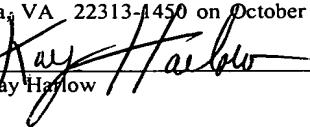
PATENT

)
) Examiner: Rachuba, Maurina T.
)
) Art Unit: 3723
)
) Atty. Docket No: LAM2P421
)
) Date: October 4, 2004
)
)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on October 4, 2004.

Signed _____


Kay Harlow

AMENDMENT AND RESPONSE TO ELECTION REQUIREMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Honorable Commissioner:

In response to the Office Action mailed August 3, 2004, which set a one month shortened period for response, which has been extended one month by the attached Transmittal, please amend the captioned application and consider the following remarks.

Amendments to the claims start on page 2.

Remarks start on page 10.

10/08/2004 LWONDIM1 00000003 10607613

01 FC:1251

110.00 OP